



<b>Form Type</b>	Distribute	<b>Version</b>	2.0	<b>Ref</b>	IPC 1752A	<b>Sectionals</b>	Material Info	<b>Subsectionals</b>	D, A
<b>Supplier Information</b>									
<b>Company Name</b>	TE Connectivity	<b>Request Document ID</b>		<b>Contact Name</b>	Benfer, David W	<b>Contact Title</b>	Staff Mfg & Process Dvl Engineer		
<b>Company Unique ID</b>	TE Connectivity	<b>Response Date</b>	2017-09-26	<b>Contact Email</b>	dave.benfer@te.com				
<b>Contact Phone Number</b>	+1-717-986-3725								
<b>Legal Statement</b>									
<b>Supplier Acceptance</b>	true								
<b>Legal Statement</b>									
The information provided in this document is based upon reasonable inquiry of our suppliers. This information is subject to change. This information does not in any way modify existing purchase specifications or existing contractual or other agreements terms between TE Connectivity (or its affiliated companies) and its customers.									
<b>Product</b>									
<b>Manufacturer Item number</b>	1-1337431-0	<b>Amount</b>	9665.0	<b>Version</b>	-	<b>Identity</b>			
<b>Manufacturer Item Name</b>	BNC Str Plg Hex 75Ohm Nickel Pltd RG179B	<b>Weight Uom</b>	mg	<b>Mfr Site</b>		<b>Authority</b>			
<b>Date</b>		<b>UOM</b>	Each						
<b>EUroHS-0508</b>	Product(s) meets EU RoHS requirements by application of the selected exemption(s)								
<b>ChinaRoHS-0508</b>	Product(s) is NOT eligible for marking with the e code under China's Measures for Administration of the control of pollution by Electronic Information Products								
<b>EUREACH-0117</b>	REACH Candidate Substances of Very High Concern ARE NOT Yet Reviewed								
<b>Complex Article Description</b>	REACH Candidate Substances of Very High Concern according to Once an Article Always an Article are Not Yet Reviewed								
<b>Product Disclosure</b>									
<b>Sub-Item/Material/Substance</b>	<b>Level</b>	<b>Name</b>	<b>Substance Category</b>	<b>Substance CAS</b>	<b>Substance Concentration</b>	<b>Quantity</b>	<b>Mass per Unit</b>	<b>UOM</b>	<b>Exemption</b>
Material	1	Ferrule Plating				1.0	3.8	mg	
Substance	2	Sulfamic acid, nickel(2+) salt (2:1)	Supplier	13770-89-3	100.0	1.0	3.8	mg	
Material	1	Insulator				1.0	258.0	mg	
Substance	2	Ethene, 1,1,2,2-tetrafluoro-, homopolymer	Supplier	9002-84-0	100.0	1.0	258.0	mg	
Material	1	Contact Pin Plating				1.0	2.1	mg	
Substance	2	Aurate(1-), bis(cyano-,kappa.C)-, potassium (1:1)	Supplier	13967-50-5	99.8	1.0	2.0958	mg	
Substance	2	Cobalt	Supplier	7440-48-4	0.2	1.0	0.0042	mg	
Material	1	Contact Pin				1.0	218.0	mg	
Substance	2	Lead	Lead/Lead Compounds	7439-92-1	1.99	1.0	4.3382	mg	6(c) Lead as an alloying element in copper containing up to 4% lead by weight
Substance	2	Zinc	Supplier	7440-66-6	35.88	1.0	78.2184	mg	
Substance	2	Iron	Supplier	7439-89-6	0.27	1.0	0.5886	mg	
Substance	2	Copper	Supplier	7440-50-8	61.86	1.0	134.8548	mg	
Material	1	Ring Plating				1.0	3.2	mg	
Substance	2	Sulfamic acid, nickel(2+) salt (2:1)	Supplier	13770-89-3	100.0	1.0	3.2	mg	
Material	1	C Ring				1.0	282.0	mg	
Substance	2	Silicon	Supplier	7440-21-3	12.78	1.0	36.0396	mg	
Substance	2	Manganese	Supplier	7439-96-5	52.88	1.0	149.1216	mg	
Substance	2	Carbon	Supplier	7440-44-0	32.82	1.0	92.5524	mg	
Substance	2	Copper	Supplier	7440-50-8	1.52	1.0	4.2864	mg	
Material	1	Ring				1.0	348.0	mg	
Substance	2	Carbon	Supplier	7440-44-0	33.82	1.0	117.6936	mg	
Substance	2	Copper	Supplier	7440-50-8	1.52	1.0	5.2896	mg	
Substance	2	Silicon	Supplier	7440-21-3	12.78	1.0	44.4744	mg	

Substance	2	Manganese	Supplier	7439-96-5	51.88	1.0	180.5424	mg	
Material	1	Spring Ring				1.0	226.0	mg	
Substance	2	Silicon	Supplier	7440-21-3	12.88	1.0	29.1088	mg	
Substance	2	Copper	Supplier	7440-50-8	11.81	1.0	26.6906	mg	
Substance	2	Manganese	Supplier	7439-96-5	26.7	1.0	60.342	mg	
Substance	2	Carbon	Supplier	7440-44-0	48.61	1.0	109.8586	mg	
Material	1	Body				1.0	3240.0	mg	
Substance	2	Copper	Supplier	7440-50-8	58.11	1.0	1882.764	mg	
Substance	2	Zinc	Supplier	7440-66-6	38.46	1.0	1246.104	mg	
Substance	2	Iron	Supplier	7439-89-6	0.28	1.0	9.072	mg	
Substance	2	Lead	Lead/Lead Compounds	7439-92-1	3.15	1.0	102.06	mg	6(c) Lead as an alloying element in copper containing up to 4% lead by weight
Material	1	Ferrule				1.0	775.0	mg	
Substance	2	Zinc	Supplier	7440-66-6	35.88	1.0	278.07	mg	
Substance	2	Copper	Supplier	7440-50-8	61.86	1.0	479.415	mg	
Substance	2	Iron	Supplier	7439-89-6	0.27	1.0	2.0925	mg	
Substance	2	Lead	Lead/Lead Compounds	7439-92-1	1.99	1.0	15.4225	mg	6(c) Lead as an alloying element in copper containing up to 4% lead by weight
Material	1	Shell				1.0	4253.0	mg	
Substance	2	Lead	Lead/Lead Compounds	7439-92-1	1.99	1.0	84.6347	mg	6(c) Lead as an alloying element in copper containing up to 4% lead by weight
Substance	2	Iron	Supplier	7439-89-6	0.27	1.0	11.4831	mg	
Substance	2	Copper	Supplier	7440-50-8	61.86	1.0	2630.9058	mg	
Substance	2	Zinc	Supplier	7440-66-6	35.88	1.0	1525.9764	mg	
Material	1	Shell Plating				1.0	6.4	mg	
Substance	2	Sulfamic acid, nickel(2+) salt (2:1)	Supplier	13770-89-3	100.0	1.0	6.4	mg	
Material	1	C Ring Plating				1.0	2.7	mg	
Substance	2	Sulfamic acid, nickel(2+) salt (2:1)	Supplier	13770-89-3	100.0	1.0	2.7	mg	
Material	1	Gasket				1.0	39.0	mg	
Substance	2	Rubber, silicone	Supplier	63394-02-5	100.0	1.0	39.0	mg	
Material	1	Body Plating				1.0	7.8	mg	
Substance	2	Sulfamic acid, nickel(2+) salt (2:1)	Supplier	13770-89-3	100.0	1.0	7.8	mg	